AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN

FREE



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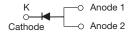
Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

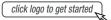
Ultra Low $V_F = 0.53 \text{ V}$ at $I_F = 4 \text{ A}$



SMPC (TO-277A)



DESIGN SUPPORT TOOLS





PRIMARY CHARACTERISTICS			
I _{F(AV)}	8.0 A		
V_{RRM}	120 V		
I _{FSM}	140 A		
V _F at I _F = 8.0 A	0.63 V		
T _J max.	175 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 1.1 mm
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meet JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8PM12	UNIT	
Device marking code		8M12		
Maximum repetitive peak reverse voltage	V _{RRM}	120	V	
Maximum DC forward current	I _F ⁽¹⁾	8.0	Α	
Maximum DC forward current	I _F ⁽²⁾	3.6		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	I _{FSM} 140		
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended pad area
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4 A	T _A = 25 °C	V _F ⁽¹⁾	0.62	-	V
	I _F = 8 A			0.76	0.84	
	I _F = 4 A	T _A = 125 °C		0.53	-	
	I _F = 8 A			0.63	0.71	
Reverse current	V _R = 90 V	T _A = 25 °C	I _R (2)	1.7	-	μΑ
	V _R = 90 V	T _A = 125 °C		1.5	-	mA
	V _R = 120 V	T _A = 25 °C		-	300	μΑ
		T _A = 125 °C		3.1	17	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	650	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER SYMBOL V8PM12			UNIT	
Typical thermal resistance	R _{θJA} (1)(2)	62	°C/W	
Typical thermal resistance	R _{0JM} (3)	4	C/ VV	

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta,JA}$ junction to ambient
- $^{(3)}$ Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PM12-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V8PM12-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	
V8PM12HM3_A/H (1)	0.10	Н	1500	7" diameter plastic tape and reel	
V8PM12HM3_A/I (1)	0.10	I	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

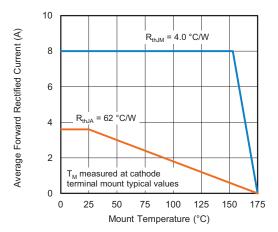


Fig. 1 - Forward Current Derating Curve

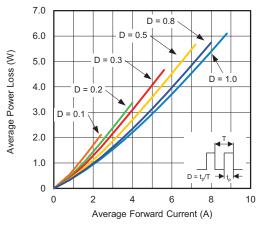


Fig. 2 - Forward Power Loss Characteristics

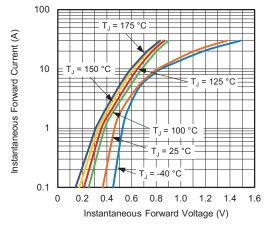


Fig. 3 - Typical Instantaneous Forward Characteristics

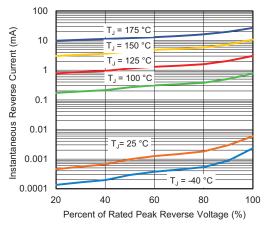


Fig. 4 - Typical Reverse Leakage Characteristics

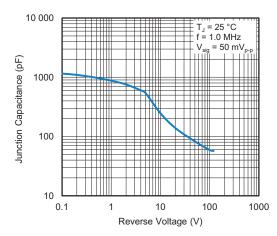


Fig. 5 - Typical Junction Capacitance

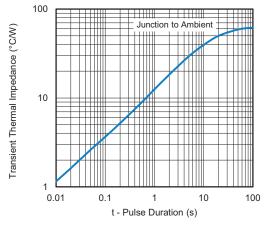
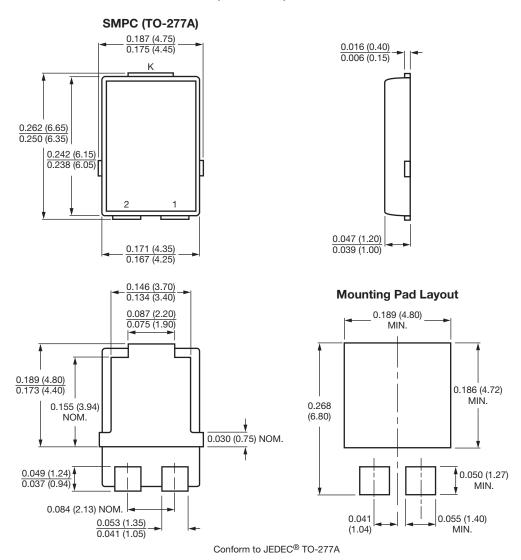


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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